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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### Details

Product Status	Active
Number of LABs/CLBs	54150
Number of Logic Elements/Cells	693120
Total RAM Bits	54190080
Number of I/O	350
Number of Gates	-
Voltage - Supply	0.97V ~ 1.03V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1156-BBGA, FCBGA
Supplier Device Package	1158-FCBGA (35x35)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc7vx690t-1ffg1158c">https://www.e-xfl.com/product-detail/xilinx/xc7vx690t-1ffg1158c</a>

Table 6: Typical Quiescent Supply Current (Cont'd)

Symbol	Description	Device	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
I <sub>CCAUQ</sub>	Quiescent V <sub>CCAU</sub> supply current	XC7V585T	114	114	114	mA
		XC7V2000T	N/A	315	315	mA
		XC7VX330T	73	73	73	mA
		XC7VX415T	88	88	88	mA
		XC7VX485T	104	104	104	mA
		XC7VX550T	147	147	147	mA
		XC7VX690T	147	147	147	mA
		XC7VX980T	N/A	183	183	mA
		XC7VX1140T	N/A	250	250	mA
I <sub>CCAUQ_IOQ</sub>	Quiescent V <sub>CCAUQ_IO</sub> supply current	XC7V585T	2	2	2	mA
		XC7V2000T	N/A	2	2	mA
		XC7VX330T	2	2	2	mA
		XC7VX415T	2	2	2	mA
		XC7VX485T	2	2	2	mA
		XC7VX550T	2	2	2	mA
		XC7VX690T	2	2	2	mA
		XC7VX980T	N/A	2	2	mA
		XC7VX1140T	N/A	2	2	mA
I <sub>CCBRAMQ</sub>	Quiescent V <sub>CCBRAM</sub> supply current	XC7V585T	34	34	34	mA
		XC7V2000T	N/A	56	56	mA
		XC7VX330T	32	32	32	mA
		XC7VX415T	38	38	38	mA
		XC7VX485T	44	44	44	mA
		XC7VX550T	63	63	63	mA
		XC7VX690T	63	63	63	mA
		XC7VX980T	N/A	65	65	mA
		XC7VX1140T	N/A	81	81	mA

**Notes:**

1. Typical values are specified at nominal voltage, 85°C junction temperatures (T<sub>j</sub>) with single-ended SelectIO resources.
2. Typical values are for blank configured devices with no output current loads, no active input pull-up resistors, all I/O pins are 3-state and floating.
3. Use the Xilinx Power Estimator (XPE) spreadsheet tool (download at <http://www.xilinx.com/power>) to calculate static power consumption for conditions other than those specified.

**Table 7** shows the minimum current, in addition to  $I_{CCQ}$ , that is required by Virtex-7 T and XT devices for proper power-on and configuration. If the current minimums shown in **Table 6** and **Table 7** are met, the device powers on after all five supplies have passed through their power-on reset threshold voltages. The FPGA must not be configured until after  $V_{CCINT}$  is applied.

Once initialized and configured, use the XPower tools to estimate current drain on these supplies.

**Table 7: Power-On Current for Virtex-7 T and XT Devices**

Device	$I_{CCINTMIN}$	$I_{CCAUXMIN}$	$I_{CCOMIN}$	$I_{CCAUX\_IO}$	$I_{CCBRAM}$	Units
	$I_{CCINTQ}^{(1)}$	$I_{CCAUXQ}^{(1)}$	$I_{CCOQ}^{(1)}$	$I_{CCOAUQ}^{(1)}$	$I_{CCBRAMQ}^{(1)}$	
XC7V585T	$I_{CCINTQ} + 2700$	$I_{CCAUXQ} + 40$	$I_{CCOQ} + 60 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 108$	mA
XC7V2000T	$I_{CCINTQ} + 4000$	$I_{CCAUXQ} + 80$	$I_{CCOQ} + 60 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 176$	mA
XC7VX330T	$I_{CCINTQ} + 1000$	$I_{CCAUXQ} + 65$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 95$	mA
XC7VX415T	$I_{CCINTQ} + 1200$	$I_{CCAUXQ} + 75$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 115$	mA
XC7VX485T	$I_{CCINTQ} + 1200$	$I_{CCAUXQ} + 80$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 140$	mA
XC7VX550T	$I_{CCINTQ} + 3300$	$I_{CCAUXQ} + 143$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 57 \text{ mA per bank}$	$I_{CCBRAMQ} + 200$	mA
XC7VX690T	$I_{CCINTQ} + 3300$	$I_{CCAUXQ} + 143$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 57 \text{ mA per bank}$	$I_{CCBRAMQ} + 200$	mA
XC7VX980T	$I_{CCINTQ} + 6500$	$I_{CCAUXQ} + 202$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 60 \text{ mA per bank}$	$I_{CCBRAMQ} + 204$	mA
XC7VX1140T	$I_{CCINTQ} + 8000$	$I_{CCAUXQ} + 235$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 63 \text{ mA per bank}$	$I_{CCBRAMQ} + 256$	mA

**Notes:**

1. Typical values are specified at nominal voltage, 25°C.
2. Use the Xilinx Power Estimator (XPE) spreadsheet tool (download at <http://www.xilinx.com/power>) to calculate maximum power-on currents.

**Table 8: Power Supply Ramp Time**

Symbol	Description	Conditions	Min	Max	Units
$T_{VCCINT}$	Ramp time from GND to 90% of $V_{CCINT}$		0.2	50	ms
$T_{VCCO}$	Ramp time from GND to 90% of $V_{CCO}$		0.2	50	ms
$T_{VCCAUX}$	Ramp time from GND to 90% of $V_{CCAUX}$		0.2	50	ms
$T_{VCCAUX\_IO}$	Ramp time from GND to 90% of $V_{CCAUX\_IO}$		0.2	50	ms
$T_{CCBRAM}$	Ramp time from GND to 90% of $V_{CCBRAM}$		0.2	50	ms
$T_{VCCO2VCCAUX}$	Allowed time per power cycle for $V_{CCO} - V_{CCAUX} > 2.625\text{V}$	$T_J = 100^\circ\text{C}^{(1)}$	–	500	ms
		$T_J = 85^\circ\text{C}^{(1)}$	–	800	
$T_{MGTAVCC}$	Ramp time from GND to 90% of $V_{MGTAVCC}$		0.2	50	ms
$T_{MGTAVTT}$	Ramp time from GND to 90% of $V_{MGTAVTT}$		0.2	50	ms
$T_{MGTVCCAUX}$	Ramp time from GND to 90% of $V_{MGTVCCAUX}$		0.2	50	ms

**Notes:**

1. Based on 240,000 power cycles with nominal  $V_{CCO}$  of 3.3V or 36,500 power cycles with a worst case  $V_{CCO}$  of 3.465V.

## Speed Grade Designations

Since individual family members are produced at different times, the migration from one category to another depends completely on the status of the fabrication process for each device. [Table 15](#) correlates the current status of each Virtex-7 T and XT device on a per speed grade basis.

[Table 15: Virtex-7 T and XT Device Speed Grade Designations](#)

Device	Speed Grade Designations		
	Advance	Preliminary	Production
XC7V585T			-3, -2, -2L, -1
XC7V2000T	-2L, -2G		-2, -1
XC7VX330T			-3, -2, -2L, -1
XC7VX415T			-3, -2, -2L, -1
XC7VX485T			-3, -2, -2L, -1
XC7VX550T			-3, -2, -2L, -1
XC7VX690T			-3, -2, -2L, -1
XC7VX980T	-2, -2L, -1		
XC7VX1140T	-2, -2L, -2G, -1		

## Production Silicon and Software Status

In some cases, a particular family member (and speed grade) is released to production before a speed specification is released with the correct label (Advance, Preliminary, Production). Any labeling discrepancies are corrected in subsequent speed specification releases.

[Table 16](#) lists the production released Virtex-7 T and XT device, speed grade, and the minimum corresponding supported speed specification version and software revisions. The software and speed specifications listed are the minimum releases required for production. All subsequent releases of software and speed specifications are valid.

[Table 16: Virtex-7 T and XT Device Production Software and Speed Specification Release](#)

Device	Speed Grade Designations				
	-3	-2G	-2	-2L	-1
XC7V585T	Vivado 2012.4 v1.08 or ISE 14.2 v1.06	N/A	Vivado 2012.4 v1.08 or ISE 14.2 v1.06		
XC7V2000T	N/A		Vivado 2012.4 v1.07		Vivado 2012.4 v1.07
XC7VX330T	Vivado 2013.1 v1.08 or ISE 14.5 v1.08	N/A	Vivado 2013.1 v1.08 or ISE 14.5 v1.08		
XC7VX415T		N/A			
XC7VX485T	Vivado 2012.4 v1.08 or ISE 14.2 v1.06	N/A	Vivado 2012.4 v1.08 or ISE 14.2 v1.06		
XC7VX550T	Vivado 2013.1 v1.08 or ISE 14.5 v1.08	N/A	Vivado 2013.1 v1.08 or ISE 14.5 v1.08		
XC7VX690T	Vivado 2013.1 v1.08 or ISE 14.5 v1.08	N/A	Vivado 2013.1 v1.08 or ISE 14.5 v1.08		
XC7VX980T	N/A	N/A			
XC7VX1140T	N/A				

### Notes:

- Blank entries indicate a device and/or speed grade in advance or preliminary status.

Table 19: 3.3V IOB High Range (HR) Switching Characteristics (Cont'd)

I/O Standard	T <sub>IOPI</sub>			T <sub>IOOP</sub>			T <sub>IOTP</sub>			Units	
	Speed Grade			Speed Grade			Speed Grade				
	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1		
HSTL_II_F	0.61	0.64	0.73	1.05	1.18	1.28	1.81	2.04	2.27	ns	
HSTL_I_18_F	0.64	0.67	0.76	1.05	1.18	1.28	1.81	2.04	2.27	ns	
HSTL_II_18_F	0.64	0.67	0.76	1.03	1.14	1.23	1.79	2.00	2.22	ns	
DIFF_HSTL_I_F	0.63	0.67	0.77	1.09	1.18	1.22	1.85	2.04	2.21	ns	
DIFF_HSTL_II_F	0.63	0.67	0.77	1.02	1.11	1.14	1.78	1.97	2.13	ns	
DIFF_HSTL_I_18_F	0.65	0.69	0.78	1.08	1.17	1.21	1.84	2.03	2.20	ns	
DIFF_HSTL_II_18_F	0.65	0.69	0.78	1.01	1.10	1.13	1.77	1.96	2.12	ns	
LVCMOS33_S4	1.31	1.40	1.60	3.77	3.90	4.00	4.53	4.76	4.99	ns	
LVCMOS33_S8	1.31	1.40	1.60	3.49	3.62	3.72	4.25	4.48	4.71	ns	
LVCMOS33_S12	1.31	1.40	1.60	3.05	3.18	3.28	3.81	4.04	4.27	ns	
LVCMOS33_S16	1.31	1.40	1.60	3.06	3.43	3.88	3.82	4.29	4.87	ns	
LVCMOS33_F4	1.31	1.40	1.60	3.22	3.36	3.45	3.98	4.22	4.44	ns	
LVCMOS33_F8	1.31	1.40	1.60	2.71	2.84	2.93	3.47	3.70	3.92	ns	
LVCMOS33_F12	1.31	1.40	1.60	2.57	2.85	3.15	3.33	3.71	4.14	ns	
LVCMOS33_F16	1.31	1.40	1.60	2.44	2.69	2.96	3.20	3.55	3.95	ns	
LVCMOS25_S4	1.08	1.16	1.32	3.08	3.22	3.31	3.84	4.08	4.30	ns	
LVCMOS25_S8	1.08	1.16	1.32	2.85	2.98	3.07	3.61	3.84	4.06	ns	
LVCMOS25_S12	1.08	1.16	1.32	2.44	2.57	2.67	3.20	3.43	3.66	ns	
LVCMOS25_S16	1.08	1.16	1.32	2.79	2.92	3.01	3.55	3.78	4.00	ns	
LVCMOS25_F4	1.08	1.16	1.32	2.71	2.84	2.93	3.47	3.70	3.92	ns	
LVCMOS25_F8	1.08	1.16	1.32	2.14	2.28	2.37	2.90	3.14	3.36	ns	
LVCMOS25_F12	1.08	1.16	1.32	2.15	2.29	2.52	2.91	3.15	3.51	ns	
LVCMOS25_F16	1.08	1.16	1.32	1.92	2.17	2.45	2.68	3.03	3.44	ns	
LVCMOS18_S4	0.64	0.66	0.74	1.55	1.68	1.78	2.31	2.54	2.77	ns	
LVCMOS18_S8	0.64	0.66	0.74	2.14	2.28	2.37	2.90	3.14	3.36	ns	
LVCMOS18_S12	0.64	0.66	0.74	2.14	2.28	2.37	2.90	3.14	3.36	ns	
LVCMOS18_S16	0.64	0.66	0.74	1.49	1.62	1.72	2.25	2.48	2.71	ns	
LVCMOS18_S24 <sup>(1)</sup>	0.64	0.66	0.74	1.74	1.92	2.08	2.50	2.78	3.07	ns	
LVCMOS18_F4	0.64	0.66	0.74	1.38	1.51	1.61	2.14	2.37	2.60	ns	
LVCMOS18_F8	0.64	0.66	0.74	1.64	1.78	1.87	2.40	2.64	2.86	ns	
LVCMOS18_F12	0.64	0.66	0.74	1.64	1.78	1.87	2.40	2.64	2.86	ns	
LVCMOS18_F16	0.64	0.66	0.74	1.52	1.68	1.81	2.28	2.54	2.80	ns	
LVCMOS18_F24 <sup>(1)</sup>	0.64	0.66	0.74	1.34	1.46	1.55	2.10	2.32	2.54	ns	
LVCMOS15_S4	0.66	0.69	0.81	1.86	2.00	2.09	2.62	2.86	3.08	ns	
LVCMOS15_S8	0.66	0.69	0.81	2.05	2.18	2.28	2.81	3.04	3.27	ns	
LVCMOS15_S12	0.66	0.69	0.81	1.83	2.03	2.23	2.59	2.89	3.22	ns	
LVCMOS15_S16	0.66	0.69	0.81	1.76	1.95	2.13	2.52	2.81	3.12	ns	

Table 19: 3.3V IOB High Range (HR) Switching Characteristics (Cont'd)

I/O Standard	T <sub>IOPI</sub>			T <sub>IOOP</sub>			T <sub>IOTP</sub>			Units	
	Speed Grade			Speed Grade			Speed Grade				
	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1		
LVCMOS15_F4	0.66	0.69	0.81	1.63	1.76	1.86	2.39	2.62	2.85	ns	
LVCMOS15_F8	0.66	0.69	0.81	1.79	1.99	2.18	2.55	2.85	3.17	ns	
LVCMOS15_F12	0.66	0.69	0.81	1.40	1.54	1.65	2.16	2.40	2.64	ns	
LVCMOS15_F16	0.66	0.69	0.81	1.37	1.51	1.61	2.13	2.37	2.60	ns	
LVCMOS12_S4	0.88	0.91	1.00	2.53	2.67	2.76	3.29	3.53	3.75	ns	
LVCMOS12_S8	0.88	0.91	1.00	2.05	2.18	2.28	2.81	3.04	3.27	ns	
LVCMOS12_S12 <sup>(1)</sup>	0.88	0.91	1.00	1.75	1.89	1.98	2.51	2.75	2.97	ns	
LVCMOS12_F4	0.88	0.91	1.00	1.94	2.07	2.17	2.70	2.93	3.16	ns	
LVCMOS12_F8	0.88	0.91	1.00	1.50	1.64	1.73	2.26	2.50	2.72	ns	
LVCMOS12_F12 <sup>(1)</sup>	0.88	0.91	1.00	1.54	1.71	1.87	2.30	2.57	2.86	ns	
SSTL135_S	0.61	0.64	0.73	1.27	1.40	1.50	2.03	2.26	2.49	ns	
SSTL15_S	0.61	0.64	0.73	1.24	1.37	1.47	2.00	2.23	2.46	ns	
SSTL18_I_S	0.64	0.67	0.76	1.59	1.74	1.85	2.35	2.60	2.84	ns	
SSTL18_II_S	0.64	0.67	0.76	1.27	1.40	1.50	2.03	2.26	2.49	ns	
DIFF_SSTL135_S	0.59	0.61	0.73	1.27	1.40	1.50	2.03	2.26	2.49	ns	
DIFF_SSTL15_S	0.63	0.67	0.77	1.24	1.37	1.47	2.00	2.23	2.46	ns	
DIFF_SSTL18_I_S	0.65	0.69	0.78	1.50	1.63	1.72	2.26	2.49	2.71	ns	
DIFF_SSTL18_II_S	0.65	0.69	0.78	1.13	1.22	1.25	1.89	2.08	2.24	ns	
SSTL135_F	0.61	0.64	0.73	1.04	1.17	1.26	1.80	2.03	2.25	ns	
SSTL15_F	0.61	0.64	0.73	1.04	1.17	1.26	1.80	2.03	2.25	ns	
SSTL18_I_F	0.64	0.67	0.76	1.12	1.22	1.26	1.88	2.08	2.25	ns	
SSTL18_II_F	0.64	0.67	0.76	1.05	1.18	1.28	1.81	2.04	2.27	ns	
DIFF_SSTL135_F	0.59	0.61	0.73	1.04	1.17	1.26	1.80	2.03	2.25	ns	
DIFF_SSTL15_F	0.63	0.67	0.77	1.04	1.17	1.26	1.80	2.03	2.25	ns	
DIFF_SSTL18_I_F	0.65	0.69	0.78	1.10	1.19	1.23	1.86	2.05	2.22	ns	
DIFF_SSTL18_II_F	0.65	0.69	0.78	1.02	1.10	1.14	1.78	1.96	2.13	ns	

**Notes:**

- This I/O standard is only available in the 3.3V high-range (HR) banks.

Table 20: 1.8V IOB High Performance (HP) Switching Characteristics (Cont'd)

I/O Standard	T <sub>IOPI</sub>			T <sub>IOOP</sub>			T <sub>IOTP</sub>			Units	
	Speed Grade			Speed Grade			Speed Grade				
	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1		
LVDCI_15	0.59	0.62	0.73	1.98	2.23	2.58	2.62	2.99	3.40	ns	
LVDCI_DV2_18	0.47	0.50	0.60	1.99	2.15	2.34	2.62	2.90	3.17	ns	
LVDCI_DV2_15	0.59	0.62	0.73	1.98	2.23	2.58	2.62	2.99	3.40	ns	
HSLVDCI_18	0.68	0.72	0.82	1.99	2.15	2.35	2.62	2.91	3.17	ns	
HSLVDCI_15	0.68	0.72	0.82	1.98	2.23	2.58	2.62	2.99	3.40	ns	
SSTL18_I_S	0.68	0.72	0.82	1.02	1.15	1.24	1.66	1.90	2.07	ns	
SSTL18_II_S	0.68	0.72	0.82	1.17	1.29	1.37	1.81	2.05	2.19	ns	
SSTL18_I_DCI_S	0.68	0.72	0.82	0.92	1.06	1.17	1.56	1.82	1.99	ns	
SSTL18_II_DCI_S	0.68	0.72	0.82	0.88	0.98	1.08	1.51	1.74	1.90	ns	
SSTL18_II_T_DCI_S	0.68	0.72	0.82	0.92	1.06	1.17	1.56	1.82	1.99	ns	
SSTL15_S	0.68	0.72	0.82	0.94	1.06	1.15	1.58	1.82	1.97	ns	
SSTL15_DCI_S	0.68	0.72	0.82	0.94	1.06	1.15	1.57	1.82	1.97	ns	
SSTL15_T_DCI_S	0.68	0.72	0.82	0.94	1.06	1.15	1.57	1.82	1.97	ns	
SSTL135_S	0.69	0.72	0.82	0.97	1.10	1.19	1.60	1.85	2.01	ns	
SSTL135_DCI_S	0.69	0.72	0.82	0.97	1.09	1.19	1.60	1.85	2.01	ns	
SSTL135_T_DCI_S	0.69	0.72	0.82	0.97	1.09	1.19	1.60	1.85	2.01	ns	
SSTL12_S	0.69	0.72	0.82	0.96	1.09	1.18	1.60	1.84	2.00	ns	
SSTL12_DCI_S	0.69	0.72	0.82	1.03	1.17	1.27	1.66	1.92	2.09	ns	
SSTL12_T_DCI_S	0.69	0.72	0.82	1.03	1.17	1.27	1.66	1.92	2.09	ns	
DIFF_SSTL18_I_S	0.75	0.79	0.92	1.02	1.15	1.24	1.66	1.90	2.07	ns	
DIFF_SSTL18_II_S	0.75	0.79	0.92	1.17	1.29	1.37	1.81	2.05	2.19	ns	
DIFF_SSTL18_I_DCI_S	0.75	0.79	0.92	0.92	1.06	1.17	1.56	1.82	1.99	ns	
DIFF_SSTL18_II_DCI_S	0.75	0.79	0.92	0.88	0.98	1.08	1.51	1.74	1.90	ns	
DIFF_SSTL18_II_T_DCI_S	0.75	0.79	0.92	0.92	1.06	1.17	1.56	1.82	1.99	ns	
DIFF_SSTL15_S	0.68	0.72	0.82	0.94	1.06	1.15	1.58	1.82	1.97	ns	
DIFF_SSTL15_DCI_S	0.68	0.72	0.82	0.94	1.06	1.15	1.57	1.82	1.97	ns	
DIFF_SSTL15_T_DCI_S	0.68	0.72	0.82	0.94	1.06	1.15	1.57	1.82	1.97	ns	
DIFF_SSTL135_S	0.69	0.72	0.82	0.97	1.10	1.19	1.60	1.85	2.01	ns	
DIFF_SSTL135_DCI_S	0.69	0.72	0.82	0.97	1.09	1.19	1.60	1.85	2.01	ns	
DIFF_SSTL135_T_DCI_S	0.69	0.72	0.82	0.97	1.09	1.19	1.60	1.85	2.01	ns	
DIFF_SSTL12_S	0.69	0.72	0.82	0.96	1.09	1.18	1.60	1.84	2.00	ns	
DIFF_SSTL12_DCI_S	0.69	0.72	0.82	1.03	1.17	1.27	1.66	1.92	2.09	ns	
DIFF_SSTL12_T_DCI_S	0.69	0.72	0.82	1.03	1.17	1.27	1.66	1.92	2.09	ns	
SSTL18_I_F	0.68	0.72	0.82	0.94	1.06	1.15	1.58	1.82	1.97	ns	
SSTL18_II_F	0.68	0.72	0.82	0.97	1.09	1.16	1.61	1.84	1.99	ns	
SSTL18_I_DCI_F	0.68	0.72	0.82	0.89	1.02	1.10	1.53	1.77	1.92	ns	
SSTL18_II_DCI_F	0.68	0.72	0.82	0.89	1.02	1.10	1.53	1.77	1.92	ns	
SSTL18_II_T_DCI_F	0.68	0.72	0.82	0.89	1.02	1.10	1.53	1.77	1.92	ns	

Table 23: OLOGIC Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Setup/Hold</b>					
TODCK/TOCKD	D1/D2 pins setup/hold with respect to CLK	0.45/-0.13	0.50/-0.13	0.58/-0.13	ns
TOOCECK/TOCKOCE	OCE pin setup/hold with respect to CLK	0.28/0.03	0.29/0.03	0.45/0.03	ns
TOSRCK/TOCKSR	SR pin setup/hold with respect to CLK	0.32/0.18	0.38/0.18	0.70/0.18	ns
TOTCK/TOCKT	T1/T2 pins setup/hold with respect to CLK	0.49/-0.16	0.56/-0.16	0.68/-0.16	ns
TOTCECK/TOCKTCE	TCE pin setup/hold with respect to CLK	0.28/0.01	0.30/0.01	0.45/0.01	ns
<b>Combinatorial</b>					
TODQ	D1 to OQ out or T1 to TQ out	0.73	0.81	0.97	ns
<b>Sequential Delays</b>					
TOCKQ	CLK to OQ/TQ out	0.41	0.43	0.49	ns
TRQ_OLOGICE2	SR pin to OQ/TQ out (HP I/O banks only)	0.63	0.70	0.83	ns
TGSRQ_OLOGICE2	Global set/reset to Q outputs (HP I/O banks only)	7.60	7.60	10.51	ns
TRQ_OLOGICE3	SR pin to OQ/TQ out (HR I/O banks only)	0.63	0.70	0.83	ns
TGSRQ_OLOGICE3	Global set/reset to Q outputs (HR I/O banks only)	7.60	7.60	10.51	ns
<b>Set/Reset</b>					
TRPW_OLOGICE2	Minimum pulse width, SR inputs (HP I/O banks only)	0.54	0.54	0.63	ns, Min
TRPW_OLOGICE3	Minimum pulse width, SR inputs (HR I/O banks only)	0.54	0.54	0.63	ns, Min

## Input Serializer/Deserializer Switching Characteristics

Table 24: ISERDES Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Setup/Hold for Control Lines</b>					
T <sub>ISCKC_BITSILIP</sub> /T <sub>ISCKC_BITSILIP</sub>	BITSILIP pin setup/hold with respect to CLKDIV	0.01/0.12	0.02/0.13	0.02/0.15	ns
T <sub>ISCKC_CE</sub> / T <sub>ISCKC_CE</sub> <sup>(2)</sup>	CE pin setup/hold with respect to CLK (for CE1)	0.39/-0.02	0.44/-0.02	0.63/-0.02	ns
T <sub>ISCKC_CE2</sub> / T <sub>ISCKC_CE2</sub> <sup>(2)</sup>	CE pin setup/hold with respect to CLKDIV (for CE2)	-0.12/0.29	-0.12/0.31	-0.12/0.35	ns
<b>Setup/Hold for Data Lines</b>					
T <sub>ISDCK_D</sub> / T <sub>ISCKD_D</sub>	D pin setup/hold with respect to CLK	-0.02/0.11	-0.02/0.12	-0.02/0.15	ns
T <sub>ISDCK_DDLY</sub> / T <sub>ISCKD_DDLY</sub>	DDLY pin setup/hold with respect to CLK (using IDELAY) <sup>(1)</sup>	-0.02/0.11	-0.02/0.12	-0.02/0.15	ns
T <sub>ISDCK_D_DDR</sub> / T <sub>ISCKD_D_DDR</sub>	D pin setup/hold with respect to CLK at DDR mode	-0.02/0.11	-0.02/0.12	-0.02/0.15	ns
T <sub>ISDCK_DDLY_DDR</sub> / T <sub>ISCKD_DDLY_DDR</sub>	D pin setup/hold with respect to CLK at DDR mode (using IDELAY) <sup>(1)</sup>	0.11/0.11	0.12/0.12	0.15/0.15	ns
<b>Sequential Delays</b>					
T <sub>ISCKO_Q</sub>	CLKDIV to out at Q pin	0.46	0.47	0.58	ns
<b>Propagation Delays</b>					
T <sub>ISDO_DO</sub>	D input to DO output pin	0.09	0.10	0.12	ns

**Notes:**

1. Recorded at 0 tap value.
2. T<sub>ISCKC\_CE2</sub> and T<sub>ISCKC\_CE2</sub> are reported as T<sub>ISCKC\_CE</sub>/T<sub>ISCKC\_CE</sub> in the timing report.

## Output Serializer/Deserializer Switching Characteristics

Table 25: OSERDES Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Setup/Hold</b>					
T <sub>OSDCK_D</sub> /T <sub>OSCKD_D</sub>	D input setup/hold with respect to CLKDIV	0.37/0.02	0.40/0.02	0.55/0.02	ns
T <sub>OSDCK_T</sub> /T <sub>OSCKD_T</sub> <sup>(1)</sup>	T input setup/hold with respect to CLK	0.49/-0.15	0.56/-0.15	0.68/-0.15	ns
T <sub>OSDCK_T2</sub> /T <sub>OSCKD_T2</sub> <sup>(1)</sup>	T input setup/hold with respect to CLKDIV	0.27/-0.15	0.30/-0.15	0.34/-0.15	ns
T <sub>OSCCK_OCE</sub> /T <sub>OSCKC_OCE</sub>	OCE input setup/hold with respect to CLK	0.28/0.03	0.29/0.03	0.45/0.03	ns
T <sub>OSCCK_S</sub>	SR (Reset) input setup with respect to CLKDIV	0.41	0.46	0.75	ns
T <sub>OSCCK_TCE</sub> /T <sub>OSCKC_TCE</sub>	TCE input setup/hold with respect to CLK	0.28/0.01	0.30/0.01	0.45/0.01	ns
<b>Sequential Delays</b>					
T <sub>OSCKO_OQ</sub>	Clock to out from CLK to OQ	0.35	0.37	0.42	ns
T <sub>OSCKO_TQ</sub>	Clock to out from CLK to TQ	0.41	0.43	0.49	ns
<b>Combinatorial</b>					
T <sub>OSDO_TTQ</sub>	T input to TQ Out	0.73	0.81	0.97	ns

**Notes:**

1. T<sub>OSDCK\_T2</sub> and T<sub>OSCKD\_T2</sub> are reported as T<sub>OSDCK\_T</sub>/T<sub>OSCKD\_T</sub> in the timing report.

## Input/Output Delay Switching Characteristics

Table 26: Input/Output Delay Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>IDELAYCTRL</b>					
T <sub>DLYCCO_RDY</sub>	Reset to ready for IDELAYCTRL	3.22	3.22	3.22	μs
F <sub>IDELAYCTRL_REF</sub>	Attribute REFCLK frequency = 200.0 <sup>(1)</sup>	200	200	200	MHz
	Attribute REFCLK frequency = 300.0 <sup>(1)</sup>	300	300	N/A	MHz
IDELAYCTRL_REF_PRECISION	REFCLK precision	±10	±10	±10	MHz
T <sub>IDELAYCTRL_RPW</sub>	Minimum reset pulse width	52.00	52.00	52.00	ns
<b>IDELAY/ODELAY</b>					
T <sub>IDELAYRESOLUTION</sub>	IDELAY/ODELAY chain delay resolution	1/(32 x 2 x F <sub>REF</sub> )			ps
T <sub>IDELAYPAT_JIT</sub> and T <sub>ODELAYPAT_JIT</sub>	Pattern dependent period jitter in delay chain for clock pattern. <sup>(2)</sup>	0	0	0	ps per tap
	Pattern dependent period jitter in delay chain for random data pattern (PRBS 23) <sup>(3)</sup>	±5	±5	±5	ps per tap
	Pattern dependent period jitter in delay chain for random data pattern (PRBS 23) <sup>(4)</sup>	±9	±9	±9	ps per tap
T <sub>IDELAY_CLK_MAX</sub> /T <sub>ODELAY_CLK_MAX</sub>	Maximum frequency of CLK input to IDELAY/ODELAY	800	800	710	MHz
T <sub>IDCCK_CE</sub> / T <sub>IDCKC_CE</sub>	CE pin setup/hold with respect to C for IDELAY	0.11/0.10	0.14/0.12	0.18/0.14	ns
T <sub>ODCCK_CE</sub> / T <sub>ODCKC_CE</sub>	CE pin setup/hold with respect to C for ODELAY	0.14/0.03	0.16/0.04	0.19/0.05	ns
T <sub>IDCCK_INC</sub> / T <sub>IDCKC_INC</sub>	INC pin setup/hold with respect to C for IDELAY	0.10/0.14	0.12/0.16	0.14/0.20	ns
T <sub>ODCCK_INC</sub> / T <sub>ODCKC_INC</sub>	INC pin setup/hold with respect to C for ODELAY	0.10/0.07	0.12/0.08	0.13/0.09	ns
T <sub>IDCCK_RST</sub> / T <sub>IDCKC_RST</sub>	RST pin setup/hold with respect to C for IDELAY	0.13/0.08	0.14/0.10	0.16/0.12	ns
T <sub>ODCCK_RST</sub> / T <sub>ODCKC_RST</sub>	RST pin setup/hold with respect to C for ODELAY	0.16/0.04	0.19/0.06	0.24/0.08	ns
T <sub>IDDO_IDATAIN</sub>	Propagation delay through IDELAY	Note 5	Note 5	Note 5	ps
T <sub>ODDO_ODATAIN</sub>	Propagation delay through ODELAY	Note 5	Note 5	Note 5	ps

**Notes:**

1. Average tap delay at 200 MHz = 78 ps, at 300 MHz = 52 ps.
2. When HIGH\_PERFORMANCE mode is set to TRUE or FALSE.
3. When HIGH\_PERFORMANCE mode is set to TRUE.
4. When HIGH\_PERFORMANCE mode is set to FALSE.
5. Delay depends on IDELAY/ODELAY tap setting. See the timing report for actual values.

Table 31: Block RAM and FIFO Switching Characteristics (Cont'd)

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Maximum Frequency</b>					
F <sub>MAX_BRAM_WF_NC</sub>	Block RAM (Write first and No change modes) When not in SDP RF mode	601.32	543.77	458.09	MHz
F <sub>MAX_BRAM_RF_PERFORMANCE</sub>	Block RAM (Read first, Performance mode) When in SDP RF mode but no address overlap between port A and port B	601.32	543.77	458.09	MHz
F <sub>MAX_BRAM_RF_DELAYED_WRITE</sub>	Block RAM (Read first, Delayed_write mode) When in SDP RF mode and there is possibility of overlap between port A and port B addresses	528.26	477.33	400.80	MHz
F <sub>MAX_CAS_WF_NC</sub>	Block RAM Cascade (Write first, No change mode) When cascade but not in RF mode	551.27	493.83	408.00	MHz
F <sub>MAX_CAS_RF_PERFORMANCE</sub>	Block RAM Cascade (Read first, Performance mode) When in cascade with RF mode and no possibility of address overlap/one port is disabled	551.27	493.83	408.00	MHz
F <sub>MAX_CAS_RF_DELAYED_WRITE</sub>	When in cascade RF mode and there is a possibility of address overlap between port A and port B	478.24	427.35	350.88	MHz
F <sub>MAX_FIFO</sub>	FIFO in all modes without ECC	601.32	543.77	458.09	MHz
F <sub>MAX_ECC</sub>	Block RAM and FIFO in ECC configuration	484.26	430.85	351.12	MHz

**Notes:**

1. The timing report shows all of these parameters as T<sub>RCKO\_DO</sub>.
2. T<sub>RCKO\_DOR</sub> includes T<sub>RCKO\_DOW</sub>, T<sub>RCKO\_DOPR</sub>, and T<sub>RCKO\_DOPW</sub> as well as the B port equivalent timing parameters.
3. These parameters also apply to synchronous FIFO with DO\_REG = 0.
4. T<sub>RCKO\_DO</sub> includes T<sub>RCKO\_DOP</sub> as well as the B port equivalent timing parameters.
5. These parameters also apply to multirate (asynchronous) and synchronous FIFO with DO\_REG = 1.
6. T<sub>RCKO\_FLAGS</sub> includes the following parameters: T<sub>RCKO\_AEMPTY</sub>, T<sub>RCKO\_AFULL</sub>, T<sub>RCKO\_EMPTY</sub>, T<sub>RCKO\_FULL</sub>, T<sub>RCKO\_RDERR</sub>, T<sub>RCKO\_WRERR</sub>.
7. T<sub>RCKO\_POINTERS</sub> includes both T<sub>RCKO\_RDCOUNT</sub> and T<sub>RCKO\_WRCOUNT</sub>.
8. The ADDR setup and hold must be met when EN is asserted (even when WE is deasserted). Otherwise, block RAM data corruption is possible.
9. These parameters include both A and B inputs as well as the parity inputs of A and B.
10. T<sub>RCKO\_FLAGS</sub> includes the following flags: AEMPTY, AFULL, EMPTY, FULL, RDERR, WRERR, RDCOUNT, and WRCOUNT.
11. RDEN and WREN must be held Low prior to and during reset. The FIFO reset must be asserted for at least five positive clock edges of the slowest clock (WRCLK or RDCLK).

## Device Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. Values are expressed in nanoseconds unless otherwise noted.

**Table 40: Clock-Capable Clock Input to Output Delay Without MMCM/PLL (Near Clock Region)**

Symbol	Description	Device	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
SSTL15 Clock-Capable Clock Input to Output Delay using Output Flip-Flop, Fast Slew Rate, <i>without</i> MMCM/PLL.						
TICKOF	Clock-capable clock input and OUTFF <i>without</i> MMCM/PLL (near clock region)	XC7V585T	5.63	6.20	6.97	ns
		XC7V2000T	N/A	5.66	6.35	ns
		XC7VX330T	5.41	5.97	6.71	ns
		XC7VX415T	5.46	5.96	6.70	ns
		XC7VX485T	5.29	5.84	6.57	ns
		XC7VX550T	5.45	6.02	6.76	ns
		XC7VX690T	5.46	6.02	6.76	ns
		XC7VX980T	N/A	6.12	6.87	ns
		XC7VX1140T	N/A	5.59	6.28	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net in a single SLR.

**Table 41: Clock-Capable Clock Input to Output Delay Without MMCM/PLL (Far Clock Region)**

Symbol	Description	Device	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
SSTL15 Clock-Capable Clock Input to Output Delay using Output Flip-Flop, Fast Slew Rate, <i>without</i> MMCM/PLL.						
TICKOFFAR	Clock-capable clock input and OUTFF <i>without</i> MMCM/PLL (far clock region)	XC7V585T	6.81	7.53	8.44	ns
		XC7V2000T	N/A	6.00	6.73	ns
		XC7VX330T	6.31	6.97	7.83	ns
		XC7VX415T	6.36	6.90	7.69	ns
		XC7VX485T	6.20	6.86	7.69	ns
		XC7VX550T	6.66	7.37	8.27	ns
		XC7VX690T	6.69	7.37	8.27	ns
		XC7VX980T	N/A	7.47	8.37	ns
		XC7VX1140T	N/A	5.93	6.65	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net in a single SLR.

## GTX Transceiver Specifications

### GTX Transceiver DC Input and Output Levels

Table 51 summarizes the DC specifications of the GTX transceivers in Virtex-7 T and XT FPGAs. Consult the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)) for further details.

Table 51: GTX Transceiver DC Specifications

Symbol	DC Parameter	Conditions	Min	Typ	Max	Units
$DV_{PPOUT}$	Differential peak-to-peak output voltage <sup>(1)</sup>	Transmitter output swing is set to maximum setting	—	—	1000	mV
$V_{CMOUTDC}$	DC common mode output voltage.	Equation based			$V_{MGTAVTT} - DV_{PPOUT}/4$	mV
$R_{OUT}$	Differential output resistance			100	—	$\Omega$
$T_{OSKEW}$	Transmitter output pair (TXP and TXN) intra-pair skew			2	12	ps
$DV_{PPIN}$	Differential peak-to-peak input voltage (external AC coupled)	>10.3125 Gb/s	150	—	1250	mV
		6.6 Gb/s to 10.3125 Gb/s	150	—	1250	mV
		$\leq 6.6$ Gb/s	150	—	2000	mV
$V_{IN}$	Absolute input voltage	DC coupled $V_{MGTAVTT} = 1.2V$	-200	—	$V_{MGTAVTT}$	mV
$V_{CMIN}$	Common mode input voltage	DC coupled $V_{MGTAVTT} = 1.2V$	—	$2/3 V_{MGTAVTT}$	—	mV
$R_{IN}$	Differential input resistance			100	—	$\Omega$
$C_{EXT}$	Recommended external AC coupling capacitor <sup>(2)</sup>				100	nF

**Notes:**

1. The output swing and preemphasis levels are programmable using the attributes discussed in the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)), and can result in values lower than reported in this table.
2. Other values can be used as appropriate to conform to specific protocols and standards.

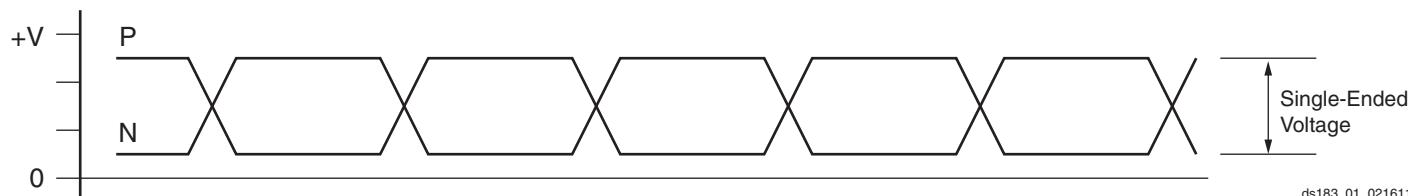


Figure 1: Single-Ended Peak-to-Peak Voltage

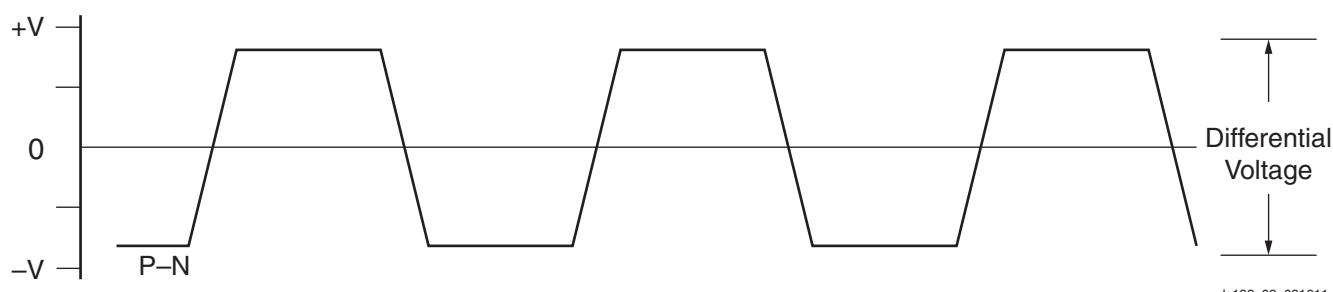


Figure 2: Differential Peak-to-Peak Voltage

**Table 52** summarizes the DC specifications of the clock input of the GTX transceiver. Consult the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)) for further details.

**Table 52: GTX Transceiver Clock DC Input Level Specification**

Symbol	DC Parameter	Min	Typ	Max	Units
V <sub>IDIFF</sub>	Differential peak-to-peak input voltage	250	—	2000	mV
R <sub>IN</sub>	Differential input resistance	—	100	—	Ω
C <sub>EXT</sub>	Required external AC coupling capacitor	—	100	—	nF

## GTX Transceiver Switching Characteristics

Consult the *7 Series FPGAs GTX/GTH Transceiver User Guide* ([UG476](#)) for further information.

**Table 53: GTX Transceiver Performance**

Symbol	Description	Output Divider	Speed Grade			Units
			-3/-2G	-2/-2L	-1 <sup>(1)</sup>	
F <sub>GTXMAX</sub> <sup>(2)</sup>	Maximum GTX transceiver data rate	12.5	10.3125	8.0	Gb/s	
F <sub>GTXMIN</sub> <sup>(2)</sup>	Minimum GTX transceiver data rate	0.500	0.500	0.500	Gb/s	
F <sub>GTXCRANGE</sub>	CPLL line rate range	1	3.2–6.6			Gb/s
		2	1.6–3.3			Gb/s
		4	0.8–1.65			Gb/s
		8	0.5–0.825			Gb/s
		16	N/A			Gb/s
F <sub>GTXQRANGE1</sub>	QPLL line rate range 1	1	5.93–8.0	5.93–8.0	5.93–8.0	Gb/s
		2	2.965–4.0	2.965–4.0	2.965–4.0	Gb/s
		4	1.4825–2.0	1.4825–2.0	1.4825–2.0	Gb/s
		8	0.74125–1.0	0.74125–1.0	0.74125–1.0	Gb/s
		16	N/A	N/A	N/A	Gb/s
F <sub>GTXQRANGE2</sub>	QPLL line rate range 2 <sup>(3)</sup>	1	9.8–12.5	9.8–10.3125	N/A	Gb/s
		2	4.9–6.25	4.9–5.15625	N/A	Gb/s
		4	2.45–3.125	2.45–2.578125	N/A	Gb/s
		8	1.225–1.5625	1.225–1.2890625	N/A	Gb/s
		16	0.6125–0.78125	0.6125–0.64453125	N/A	Gb/s
F <sub>GCPLLRANGE</sub>	GTX transceiver CPLL frequency range	1.6–3.3	1.6–3.3	1.6–3.3	GHz	
F <sub>GQPLL RANGE1</sub>	GTX transceiver QPLL frequency range 1	5.93–8.0	5.93–8.0	5.93–8.0	GHz	
F <sub>GQPLL RANGE2</sub>	GTX transceiver QPLL frequency range 2	9.8–12.5	9.8–10.3125	N/A	GHz	

### Notes:

- The -1 speed grade requires a 4-byte internal data width for operation above 5.0 Gb/s. A -1 speed grade with V<sub>CCINT</sub> = 0.9V, as described in the *Lowering Power using the Voltage Identification Bit* application note ([XAPP555](#)), requires a 4-byte internal data width for operation above 3.8 Gb/s.
- Data rates between 8.0 Gb/s and 9.8 Gb/s are not available.
- For QPLL line rate range 2, the maximum line rate with the divider N set to 66 is 10.3125Gb/s.

**Table 54: GTX Transceiver Dynamic Reconfiguration Port (DRP) Switching Characteristics**

Symbol	Description	Speed Grade			Units
		-3/-2G	-2/-2L	-1	
F <sub>GTXDRPCLK</sub>	GTXDRPCLK maximum frequency	175.01	175.01	156.25	MHz

Table 55: GTX Transceiver Reference Clock Switching Characteristics

Symbol	Description	Conditions	All Speed Grades			Units
			Min	Typ	Max	
$F_{GCLK}$	Reference clock frequency range	-3 speed grade	60	—	700	MHz
		All other speed grades	60	—	670	MHz
$T_{RCLK}$	Reference clock rise time	20% – 80%	—	200	—	ps
$T_{FCLK}$	Reference clock fall time	80% – 20%	—	200	—	ps
$T_{DCREF}$	Reference clock duty cycle	Transceiver PLL only	40	50	60	%

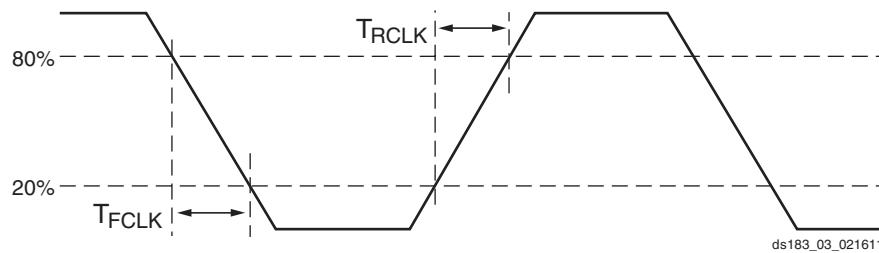


Figure 3: Reference Clock Timing Parameters

Table 56: GTX Transceiver PLL/Lock Time Adaptation

Symbol	Description	Conditions	All Speed Grades			Units
			Min	Typ	Max	
$T_{LOCK}$	Initial PLL lock		—	—	1	ms
$T_{DLOCK}$	Clock recovery phase acquisition and adaptation time for decision feedback equalizer (DFE).	After the PLL is locked to the reference clock, this is the time it takes to lock the clock data recovery (CDR) to the data present at the input.	—	50,000	$37 \times 10^6$	UI
	Clock recovery phase acquisition and adaptation time for low-power mode (LPM) when the DFE is disabled.		—	50,000	$2.3 \times 10^6$	UI

Table 59: GTX Transceiver Receiver Switching Characteristics

Symbol	Description		Min	Typ	Max	Units
$F_{GTXRX}$	Serial data rate	RX oversampler not enabled	0.500	—	$F_{GTXMAX}$	Gb/s
$T_{RXELECIDLE}$	Time for RXELECIDLE to respond to loss or restoration of data		—	10	—	ns
$RX_{OOBVDP}$	OOB detect threshold peak-to-peak		60	—	150	mV
$RX_{SST}$	Receiver spread-spectrum tracking <sup>(1)</sup>	Modulated @ 33 KHz	-5000	—	0	ppm
$RX_{RL}$	Run length (CID)		—	—	512	UI
$RX_{PPMTOL}$	Data/REFCLK PPM offset tolerance	Bit rates ≤ 6.6 Gb/s	-1250	—	1250	ppm
		Bit rates > 6.6 Gb/s and ≤ 8.0 Gb/s	-700	—	700	ppm
		Bit rates > 8.0 Gb/s	-200	—	200	ppm
<b>SJ Jitter Tolerance<sup>(2)</sup></b>						
$JT_{SJ12.5}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	12.5 Gb/s	0.3	—	—	UI
$JT_{SJ11.18}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	11.18 Gb/s	0.3	—	—	UI
$JT_{SJ10.32}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	10.32 Gb/s	0.3	—	—	UI
$JT_{SJ9.95}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	9.95 Gb/s	0.3	—	—	UI
$JT_{SJ9.8}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	9.8 Gb/s	0.3	—	—	UI
$JT_{SJ8.0}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	8.0 Gb/s	0.44	—	—	UI
$JT_{SJ6.6\_QPLL}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	6.6 Gb/s	0.48	—	—	UI
$JT_{SJ6.6\_CPLL}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	6.6 Gb/s	0.44	—	—	UI
$JT_{SJ5.0}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	5.0 Gb/s	0.44	—	—	UI
$JT_{SJ4.25}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	4.25 Gb/s	0.44	—	—	UI
$JT_{SJ3.75}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.75 Gb/s	0.44	—	—	UI
$JT_{SJ3.2}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.2 Gb/s <sup>(4)</sup>	0.45	—	—	UI
$JT_{SJ3.2L}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.2 Gb/s <sup>(5)</sup>	0.45	—	—	UI
$JT_{SJ2.5}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	2.5 Gb/s <sup>(6)</sup>	0.5	—	—	UI
$JT_{SJ1.25}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	1.25 Gb/s <sup>(7)</sup>	0.5	—	—	UI
$JT_{SJ500}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	500 Mb/s	0.4	—	—	UI
<b>SJ Jitter Tolerance with Stressed Eye<sup>(2)</sup></b>						
$JT_{TJSE3.2}$	Total jitter with stressed eye <sup>(8)</sup>	3.2 Gb/s	0.70	—	—	UI
$JT_{TJSE6.6}$		6.6 Gb/s	0.70	—	—	UI
$JT_{SJSE3.2}$	Sinusoidal jitter with stressed eye <sup>(8)</sup>	3.2 Gb/s	0.1	—	—	UI
$JT_{SJSE6.6}$		6.6 Gb/s	0.1	—	—	UI

**Notes:**

1. Using RXOUT\_DIV = 1, 2, and 4.
2. All jitter values are based on a bit error ratio of  $1e^{-12}$ .
3. The frequency of the injected sinusoidal jitter is 80 MHz.
4. CPLL frequency at 3.2 GHz and RXOUT\_DIV = 2.
5. CPLL frequency at 1.6 GHz and RXOUT\_DIV = 1.
6. CPLL frequency at 2.5 GHz and RXOUT\_DIV = 2.
7. CPLL frequency at 2.5 GHz and RXOUT\_DIV = 4.
8. Composite jitter with RX equalizer enabled. DFE disabled.

Table 70: GTH Transceiver Reference Clock Switching Characteristics

Symbol	Description	Conditions	All Speed Grades			Units
			Min	Typ	Max	
$F_{GCLK}$	Reference clock frequency range		60	—	820	MHz
$T_{RCLK}$	Reference clock rise time	20% – 80%	—	200	—	ps
$T_{FCLK}$	Reference clock fall time	80% – 20%	—	200	—	ps
$T_{DCREF}$	Reference clock duty cycle	Transceiver PLL only	40	50	60	%

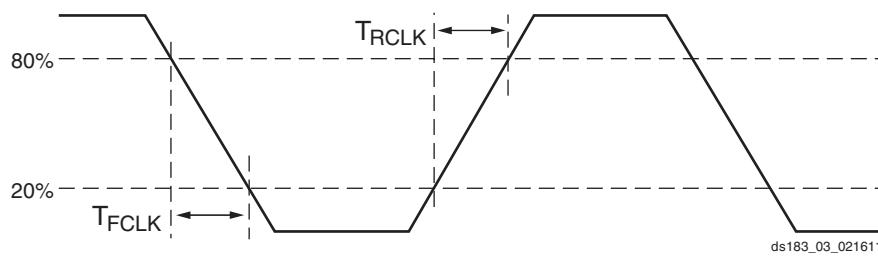


Figure 6: Reference Clock Timing Parameters

Table 71: GTH Transceiver PLL/Lock Time Adaptation

Symbol	Description	Conditions	All Speed Grades			Units
			Min	Typ	Max	
$T_{LOCK}$	Initial PLL lock		—	—	1	ms
$T_{DLOCK}$	Clock recovery phase acquisition and adaptation time for decision feedback equalizer (DFE).	After the PLL is locked to the reference clock, this is the time it takes to lock the clock data recovery (CDR) to the data present at the input.	—	50,000	$37 \times 10^6$	UI
	Clock recovery phase acquisition and adaptation time for low-power mode (LPM) when the DFE is disabled.		—	50,000	$2.3 \times 10^6$	UI

Table 80: CPRI Protocol Characteristics (GTH Transceivers)

Description	Line Rate (Mb/s)	Min	Max	Units
<b>CPRI Transmitter Jitter Generation</b>				
Total transmitter jitter	614.4	–	0.35	UI
	1228.8	–	0.35	UI
	2457.6	–	0.35	UI
	3072.0	–	0.35	UI
	4915.2	–	0.3	UI
	6144.0	–	0.3	UI
	9830.4	–	Note 1	UI
<b>CPRI Receiver Frequency Jitter Tolerance</b>				
Total receiver jitter tolerance	614.4	0.65	–	UI
	1228.8	0.65	–	UI
	2457.6	0.65	–	UI
	3072.0	0.65	–	UI
	4915.2	0.95	–	UI
	6144.0	0.95	–	UI
	9830.4	Note 1	–	UI

**Notes:**

- Tested per SFP+ specification, see [Table 79](#).

**Integrated Interface Block for PCI Express Designs Switching Characteristics**

More information and documentation on solutions for PCI Express designs can be found at:

<http://www.xilinx.com/technology/protocols/pciexpress.htm>

Table 81: Maximum Performance for PCI Express Designs

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
FPIPECLK	Pipe clock maximum frequency	250.00	250.00	250.00	MHz
FUSERCLK	User clock maximum frequency	500.00	500.00	250.00	MHz
FUSERCLK2	User clock 2 maximum frequency	250.00	250.00	250.00	MHz
FRPCLK	DRP clock maximum frequency	250.00	250.00	250.00	MHz

Table 82: XADC Specifications (Cont'd)

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
<b>XADC Reference<sup>(5)</sup></b>						
External Reference	V <sub>REFP</sub>	Externally supplied reference voltage	1.20	1.25	1.30	V
On-Chip Reference		Ground V <sub>REFP</sub> pin to AGND, T <sub>j</sub> = -40°C to 100°C	1.2375	1.25	1.2625	V

**Notes:**

- Offset and gain errors are removed by enabling the XADC automatic gain calibration feature. The values are specified for when this feature is enabled.
- Only specified for new BitGen option XADCEnhancedLinearity = ON.
- For a detailed description, see the ADC chapter in the *7 Series FPGAs and Zynq-7000 AP SoC XADC Dual 12-Bit 1 MSPS Analog-to-Digital Converter* ([UG480](#)).
- For a detailed description, see the Timing chapter in the *7 Series FPGAs and Zynq-7000 AP SoC XADC Dual 12-Bit 1 MSPS Analog-to-Digital Converter* ([UG480](#)).
- Any variation in the reference voltage from the nominal V<sub>REFP</sub> = 1.25V and V<sub>REFN</sub> = 0V will result in a deviation from the ideal transfer function. This also impacts the accuracy of the internal sensor measurements (i.e., temperature and power supply). However, for external ratio metric type applications allowing reference to vary by ±4% is permitted. On-chip reference variation is ±1%.

## Configuration Switching Characteristics

Table 83: Configuration Switching Characteristics

Symbol	Description	Virtex-7 T and XT Devices	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
<b>Power-up Timing Characteristics</b>						
T <sub>PL</sub> <sup>(1)</sup>	Program latency		5	5	5	ms, Max
T <sub>POR</sub> <sup>(1)</sup>	Power-on reset (50ms ramp rate time)	10/50	10/50	10/50	ms, Min/Max	
	Power-on reset (1ms ramp rate time)	10/35	10/35	10/35	ms, Min/Max	
T <sub>PROGRAM</sub>	Program pulse width	250	250	250	ns, Min	
<b>CCLK Output (Master Mode)</b>						
T <sub>ICCK</sub>	Master CCLK output delay	150	150	150	ns, Min	
T <sub>MCCKL</sub>	Master CCLK clock Low time duty cycle	40/60	40/60	40/60	%, Min/Max	
T <sub>MCCKH</sub>	Master CCLK clock High time duty cycle	40/60	40/60	40/60	%, Min/Max	
F <sub>MCCK</sub>	Master CCLK frequency	100	100	100	MHz, Max	
	Master CCLK frequency for AES encrypted x16	50	50	50	MHz, Max	
F <sub>MCCK_START</sub>	Master CCLK frequency at start of configuration	3	3	3	MHz, Typ	
F <sub>MCCKTOL</sub>	Frequency tolerance, master mode with respect to nominal CCLK.	±50	±50	±50	%, Max	
<b>CCLK Input (Slave Modes)</b>						
T <sub>SCCKL</sub>	Slave CCLK clock minimum Low time	2.5	2.5	2.5	ns, Min	
T <sub>SCCKH</sub>	Slave CCLK clock minimum High time	2.5	2.5	2.5	ns, Min	
F <sub>SCCK</sub>	Slave CCLK frequency	100	100	100	MHz, Max	
<b>EMCCLK Input (Master Mode)</b>						
T <sub>EMCCKL</sub>	External master CCLK Low time	2.5	2.5	2.5	ns, Min	
T <sub>EMCCKH</sub>	External master CCLK High time	2.5	2.5	2.5	ns, Min	
F <sub>EMCCK</sub>	External master CCLK frequency	100	100	100	MHz, Max	
<b>Internal Configuration Access Port</b>						
F <sub>ICAPCK</sub>	Internal configuration access port (ICAPE2)	100.00	100.00	100.00	MHz, Max	

Date	Version	Description
08/03/2012	1.5	<p>Updated the descriptions, changed <math>V_{IN}</math> and <a href="#">Note 2</a> and added <a href="#">Note 4</a> in <a href="#">Table 1</a>. In <a href="#">Table 2</a>, changed descriptions and notes, removed Note 7, changed GTX transceiver parameters and values and added <a href="#">Note 12</a> and <a href="#">Note 13</a>. Updated parameters in <a href="#">Table 3</a>. Added <a href="#">Table 4</a> and <a href="#">Table 5</a>. Updated the values for in <a href="#">Table 7</a>. Updated LVCMS12 and the SSTLs in <a href="#">Table 9</a>. Updated many of the specifications in <a href="#">Table 10</a> and <a href="#">Table 11</a>.</p> <p>Updated the <a href="#">AC Switching Characteristics</a> section, based upon <a href="#">Table 14</a>, for the ISE 14.2 speed specifications throughout the document with appropriate changes to <a href="#">Table 15</a> and <a href="#">Table 16</a> including production release of the XC7VX485T in the -2 and -1 speed designations.</p> <p>Added notes and specifications to <a href="#">Table 18</a>. Updated the <a href="#">IOB Pad Input/Output/3-State</a> discussion and changed <a href="#">Table 21</a> by adding <math>T_{IOIBUFDISABLE}</math>.</p> <p>Removed many of the combinatorial delay specifications and <math>T_{CINCK}/T_{CKCIN}</math> from <a href="#">Table 28</a>.</p> <p>Rearranged <a href="#">Table 51</a> including moving some parameters to <a href="#">Table 1</a>. Added <a href="#">Table 56</a>. Updated <a href="#">Table 57</a>. In <a href="#">Table 59</a>, updated SJ Jitter Tolerance with Stressed Eye section, <a href="#">page 48</a> and <a href="#">Note 8</a>. Added <a href="#">Note 1</a>, <a href="#">Note 2</a>, and <a href="#">Note 3</a> to <a href="#">Table 62</a>. Added <a href="#">Note 1</a> and <a href="#">Note 2</a> to <a href="#">Table 63</a>, and line rate ranges. Updated <a href="#">Table 64</a> including adding <a href="#">Note 1</a>. Updated <a href="#">Table 65</a> including adding <a href="#">Note 1</a>. In <a href="#">Table 82</a> updated <a href="#">Note 1</a> and added <a href="#">Note 4</a>. In <a href="#">Table 83</a>, updated <math>T_{POR}</math> and <math>F_{EMCCK}</math>.</p>
09/20/2012	1.6	Removed the XC7V1500T device from data sheet. In <a href="#">Table 2</a> , revised $V_{CCINT}$ and $V_{CCBRAM}$ and added <a href="#">Note 3</a> . Updated some of the values in <a href="#">Table 7</a> . Revised <a href="#">Table 15</a> and <a href="#">Table 16</a> to include production release of the XC7V585T in the -2 and -1 speed designations. Added values for the XC7V585T in <a href="#">Table 50</a> . Updated <a href="#">Note 2</a> in <a href="#">Table 58</a> .
09/26/2012	1.7	Revised <a href="#">Table 15</a> and <a href="#">Table 16</a> to include production release of the XC7VX485T in the -3 speed designation.
10/19/2012	1.8	<p>Revised <a href="#">Table 15</a> and <a href="#">Table 16</a> to include production release of the XC7VX485T in the -2L (1.0V) speed designation.</p> <p>Removed -2L (0.9V) speed specifications from data sheet, this change includes edits to <math>V_{CCINT}</math> and <math>V_{CCBRAM}</math> in <a href="#">Table 2</a>, editing <a href="#">Note 1</a> and removing Note 2 in <a href="#">Table 53</a>. Also in <a href="#">Table 53</a>, updated the <math>F_{GTXMAX}</math>, <math>F_{GTXQRANGE1}</math>, and <math>F_{GQPLL RANGE1}</math> specification for -1 speed grade from 6.6 Gb/s to 8.0 Gb/s. Edited <a href="#">Note 4</a> in <a href="#">Table 57</a> and <a href="#">Note 3</a> in <a href="#">Table 72</a>.</p>
12/12/2012	1.9	<p>Updated the <a href="#">AC Switching Characteristics</a> section, based upon <a href="#">Table 14</a>, for the ISE 14.3 speed specifications throughout the document. Revised <a href="#">Table 15</a> and <a href="#">Table 16</a> to include production release of the XC7V585T in the -3 and -2L(1.0V) speed designations. Updated the notes in <a href="#">Table 50</a>.</p> <p>Updated <a href="#">GTH Transceiver Specifications</a> including removal of GTH Transceiver DC Characteristics section (use the XPE (download at <a href="http://www.xilinx.com/power">http://www.xilinx.com/power</a>)). Updated <a href="#">Table 68</a> and added <a href="#">Table 71</a>, <a href="#">Table 73</a>, and <a href="#">Table 74</a>. Removed Note 4 from <a href="#">Table 82</a>.</p>
12/24/2012	1.10	<p>Updated the <a href="#">AC Switching Characteristics</a> section, based upon <a href="#">Table 14</a>, for the ISE 14.4 and Vivado 2012.4 speed specifications throughout the document. Revised the XC7V2000T in the -1 and -2 speed designations <a href="#">Table 15</a> to preliminary.</p> <p>Added the <a href="#">GTH Transceiver Protocol Jitter Characteristics</a> section. Updated <math>T_{TCKTDO}</math> and added <a href="#">Internal Configuration Access Port</a> section to <a href="#">Table 83</a>.</p>
01/31/2013	1.11	Added <a href="#">Note 2</a> to <a href="#">Table 2</a> . Revised <a href="#">Table 15</a> and <a href="#">Table 16</a> to include production release of the XC7V2000T in the -1 and -2 speed specifications. Updated <a href="#">Note 1</a> in <a href="#">Table 35</a> . Updated the notes in <a href="#">Table 37</a> , <a href="#">Table 40</a> through <a href="#">Table 43</a> , <a href="#">Table 46</a> , and <a href="#">Table 47</a> . In <a href="#">Table 66</a> , updated $D_{VPPIN}$ . In <a href="#">Table 67</a> , updated $V_{IDIFF}$ . Removed $T_{LOCK}$ and $T_{PHASE}$ from <a href="#">Table 70</a> . Updated $T_{DLOCK}$ in <a href="#">Table 71</a> .
03/07/2013	1.12	<p>Updated the <a href="#">AC Switching Characteristics</a> section, based upon <a href="#">Table 14</a>, for the ISE 14.5 and Vivado 2013.1 speed specifications throughout the document. Revised <a href="#">Table 15</a> and <a href="#">Table 16</a> to include production release of the XC7VX690T.</p> <p>Revised <math>D_{VPPOUT}</math> in <a href="#">Table 66</a>. Updated values in <a href="#">Table 67</a> and <a href="#">Table 74</a>. Removed Note 1 from <a href="#">Table 68</a>. Updated <math>MMCM\_F_{PFDMAX}</math> in <a href="#">Table 38</a> and <math>PLL\_F_{PFDMAX}</math> in <a href="#">Table 39</a>. Added skew values to <a href="#">Table 50</a>.</p>